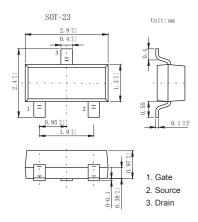


N-Channel Enhancement Mode

Field Effect Transistor



Features

- V_{DS} (V) = 30V
- ID = 5.8 A (VGS = 10V)
- lacktriangle RDS(ON) \leq 28m Ω (VGS = 10V)
- RDS(ON) < 33m Ω (VGS = 4.5V)
- RDS(ON) < 52m Ω (VGS = 2.5V)



■ Absolute Maximum Ratings Ta = 25°C

Parameter		Symbol	Rating	Unit	
Drain-Source Voltage		VDS	30	V	
Gate-Source Voltage		Vgs	±12	V	
Continuous Drain Current	us Drain Current TA=25℃		5.8		
	TA=70°C	טו	4.9	Α	
Pulsed Drain Current *		Ірм	30		
Power Dissipation	Ta=25℃	Pp	1.4	W	
	TA=70°C	I D	1	٧٧	
Thermal Resistance.Junction- to-Ambient		RthJA	125	°C/W	
Thermal Resistance.Junction- to-Case		Rthc	60	°C/W	
Junction and Storage Temperature Range		TJ, TSTG	-55 to 150	$^{\circ}\!\mathbb{C}$	

^{*} Repetitive rating, pulse width limited by junction temperature.



N-Channel Enhancement Mode

Field Effect Transistor

■ Electrical Characteristics Ta = 25 °C

Parameter	Symbol	Testconditions	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VDSS	ID=250 μ A, VGS=0V	30			V
Zeer Oote Vellage Besig Ourset	IDSS	VDS=24V, VGS=0V			1	μА
Zero Gate Voltage Drain Current		VDS=24V, VGS=0V ,TJ=55°C			5	
Gate-Body leakage current	Igss	Vps=0V, Vgs=±12V			±100	nA
Gate Threshold Voltage	VGS(th)	VDS=VGS ID=250 μ A	0.7	1.1	1.4	V
Static Drain-Source On-Resistance	Rds(on)	VGS=10V, ID=5.8A VGS=10V, ID=5.8A TJ=125℃		22.8	28	m Ω
				32	39	
		VGS=4.5V, ID=5A		27.3	33	mΩ
		Vgs=2.5V, ID=4A		43.3	52	mΩ
On state drain current	Id(on)	Vgs=4.5V, Vps=5V	30			Α
Forward Transconductance	grs	VDS=5V, ID=5A	10	15		S
Input Capacitance	Ciss	Vgs=0V, Vbs=15V, f=1MHz		823	1050	pF
Output Capacitance	Coss			99		pF
Reverse Transfer Capacitance	Crss			77		pF
Gate resistance	Rg	Vgs=0V, Vps=0V, f=1MHz		1.4	3.6	Ω
Total Gate Charge	Qg			9.7	12	nC
Gate Source Charge	Qgs	Vgs=4.5V, Vds=15V, Id=5.8A		1.6		nC
Gate Drain Charge	Qgd]		3.1		nC
Turn-On DelayTime	tD(on)			3.3	5	ns
Turn-On Rise Time	tr	Vgs=10V, Vds=15V, RL=2.7 Ω ,Rgen=3 Ω		4.8	7	ns
Turn-Off DelayTime	tD(off)			26.3	40	ns
Turn-Off Fall Time	tf			4.1	6	ns
Body Diode Reverse Recovery Time	trr	IF=5A, dı/dt=100A/ μ s		16	20	ns
Body Diode Reverse Recovery Charge	Qrr	IF=5A, dı/dt=100A/ μ s		8.9	12	nC
Maximum Body-Diode Continuous Current	Is				2.5	А
Diode Forward Voltage	Vsp	Is=1A,VGS=0V		0.71	1	V

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N-Channel Enhancement Mode

Field Effect Transistor

■ Typical Characterisitics

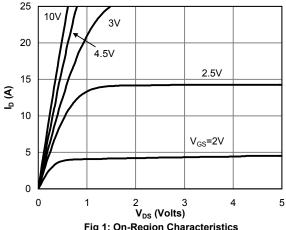


Fig 1: On-Region Characteristics

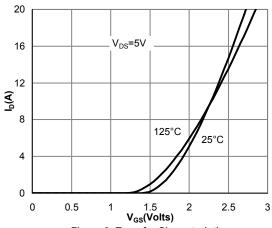


Figure 2: Transfer Characteristics

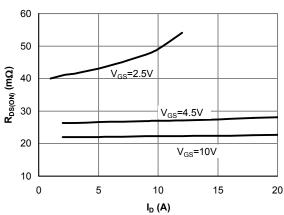


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

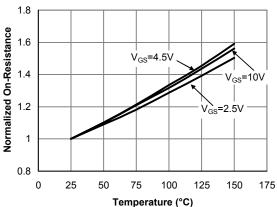


Figure 4: On-Resistance vs. Junction Temperature

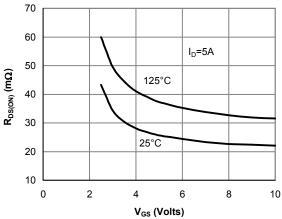


Figure 5: On-Resistance vs. Gate-Source Voltage

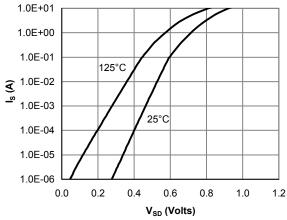


Figure 6: Body-Diode Characteristics

N-Channel Enhancement Mode

Field Effect Transistor

■ Typical Characterisitics

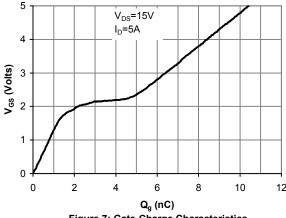


Figure 7: Gate-Charge Characteristics

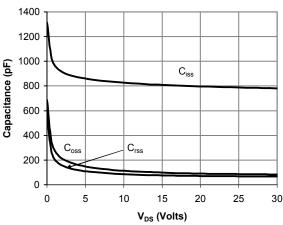


Figure 8: Capacitance Characteristics

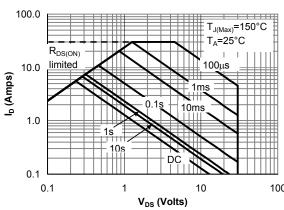


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

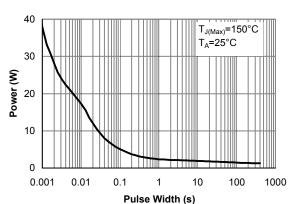


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

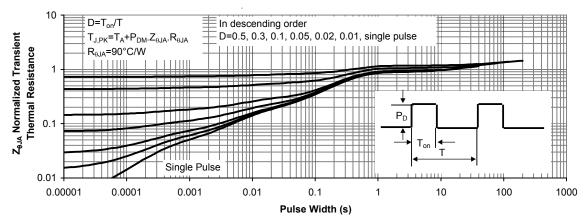


Figure 11: Normalized Maximum Transient Thermal Impedance